

Description

The AP01P10I uses advanced trench technology to provide excellent R_{DS(ON)}, low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.

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General Features

 $V_{DS} = -100V I_{D} = -0.9 A$

 $R_{DS(ON)} < 0.65\Omega$ @ V_{GS} =10V

Application

Battery protection

Load switch

Uninterruptible power supply



0107

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Package Marking and Ordering Information

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Product ID	Pack	Marking	Qty(PCS)	
AP01P10I	SOT-23	0107	3000	

Absolute Maximum Ratings (Tc=25°Cunless otherwise noted)

Symbol	Parameter	Rating	Units
V _D s	Drain-Source Voltage	-100	V
Vgs	Gate-Source Voltage ±20		V
I _D @T _A =25°C	Continuous Drain Current, V _{GS} @ -10V ¹	-0.9	А
ID@TA=70°C	Continuous Drain Current, V _{GS} @ -10V ¹ -0.7		А
Ірм	Pulsed Drain Current ² -1.8		Α
P _D @T _A =25°C	Total Power Dissipation ³	1	W
Тѕтс	Storage Temperature Range -55 to 150		°C
TJ	Operating Junction Temperature Range -55 to 150		°C
Reja	Thermal Resistance Junction-ambient ¹ 125		°C/W
Rejc	Thermal Resistance Junction-Case ¹ 80 °0		°C/W





Electrical Characteristics (T_J=25°C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BVDSS	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =-250uA	-100			V
∆BVDSS/∆ TJ	BVDSS Temperature Coefficient	Reference to 25 °C , I _D =-1mA		-0.0624		V/°C
<u> </u>		V _{GS} =-10V , I _D =-0.8A		0.52	0.65	
RDS(ON) VGS(th)	Static Drain-Source On-Resistance ² Gate Threshold Voltage	V _{GS} =-4.5V , I _D =-0.4A	-1.0	0.56 -1.5	0.7 -2.5	Ω V
v GG(III)	Gate Tilleshold Voltage		-1.0	-1.5	-2.5	V
$\triangle V_{GS(th)}$	V _{GS(th)} Temperature Coefficient	V _{GS} =V _{DS} , I _D =-250uA		4.5		mV/°C
		V _{DS} =-80V , V _{GS} =0V , T _J =25 ℃			10	
IDSS	Drain-Source Leakage Current	V _{DS} =-80V , V _{GS} =0V , T _J =55 ℃			100	uA
IGSS	Gate-Source Leakage Current	V _{GS} =±20V , V _{DS} =0V			±100	nA
gfs	Forward Transconductance	V _{DS} =-5V , I _D =-0.8A		3		S
Rg	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz		16	32	Ω
Qg	Total Gate Charge (-4.5V)			4.5		
Qgs	Gate-Source Charge	V _{DS} =-15V , V _{GS} =-4.5V , I _D =- 0.5A		1.14		nC
Qgd	Gate-Drain Charge			1.5		
Td(on)	Turn-On Delay Time			13.6		
Tr	Rise Time	V _{DD} =-50V , V _{GS} =-10V , R _G =3.3 □ I _D =-0.5A		6.8		ns
Td(off)	Turn-Off Delay Time			34		
Tf	Fall Time			3		
Ciss	Input Capacitance			553		
Coss	Output Capacitance	V _{DS} =-15V , V _{GS} =0V , f=1MHz		29		pF
Crss	Reverse Transfer Capacitance			20		
IS	Continuous Source Current ^{1,4}	V _G =V _D =0V , Force Current			-0.9	Α
ISM	Pulsed Source Current ^{2,4}				-1.8	Α
VSD	Diode Forward Voltage ²	V _{GS} =0V , I _S =-1A , T _J =25°C			-1.2	V
Note :			1			

Note:

- 1.The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width $\leq 300 \text{us}$, duty cycle $\leq 2\%$
- 3. The power dissipation is limited by 150°C junction temperature
- $4 \ . The \ data \ is \ theoretically \ the \ same \ as \ I_D \ and \ I_{DM} \ , \ in \ real \ applications \ , \ should \ be \ limited \ by \ total \ power \ dissipation.$



Typical Characteristics

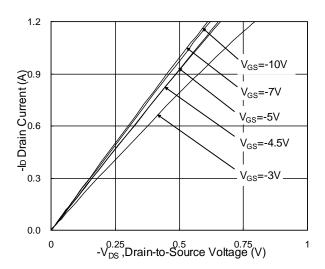


Fig.1 Typical Output Characteristics

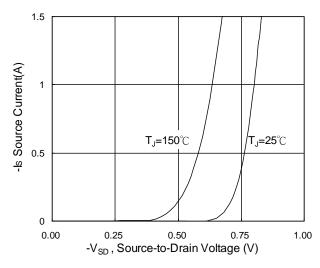


Fig.3 Forward Characteristics Of Reverse

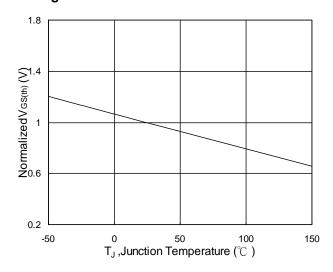


Fig.5 Normalized V_{GS(th)} vs. T_J

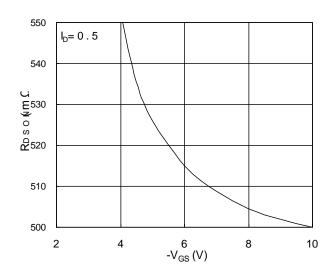


Fig.2 On-Resistance vs. Gate-Source

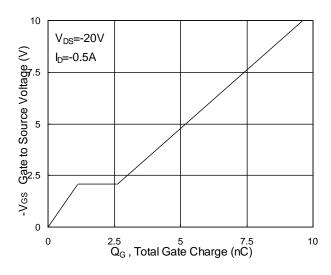


Fig.4 Gate-Charge Characteristics

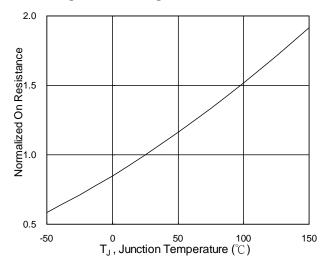
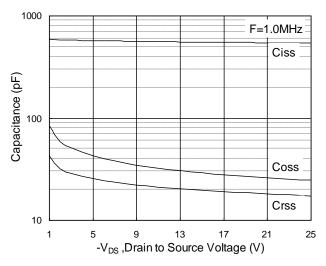


Fig.6 Normalized R_{DSON} vs. T_J







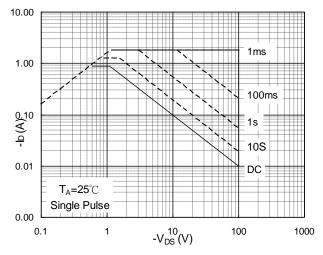


Fig.7 Capacitance

Fig.8 Safe Operating Area

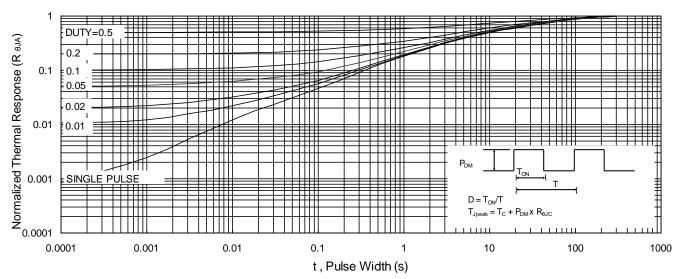
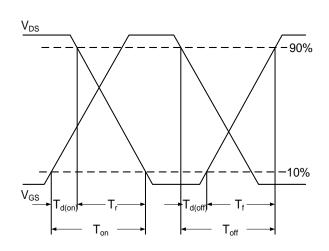


Fig.9 Normalized Maximum Transient Thermal Impedance



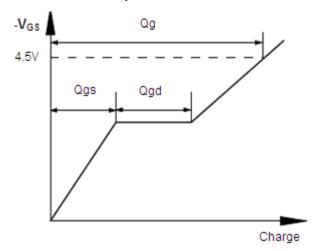
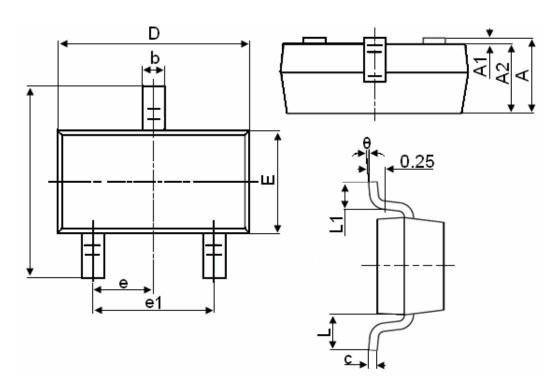


Fig.10 Switching Time Waveform

Fig.11 Gate Charge Waveform



SOT-23 Package Information



Symbol	Dimensions in Millimeters		
	MIN.	MAX.	
Α	0.900	1.150	
A1	0.000	0.100	
A2	0.900	1.050	
b	0.300	0.500	
С	0.080	0.150	
D	2.800	3.000	
Е	1.200	1.400	
E1	2.250	2.550	
е	0.950TYP		
e1	1.800	2.000	
L	0.550REF		
L1	0.300	0.500	
θ	0°	8°	



-100V P-Channel Enhancement Mode MOSFET Attention

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